CUSTOMIZABLE ANALYSIS REPORT (CAR TOOL) THE RENESAS FMEDA TOOL

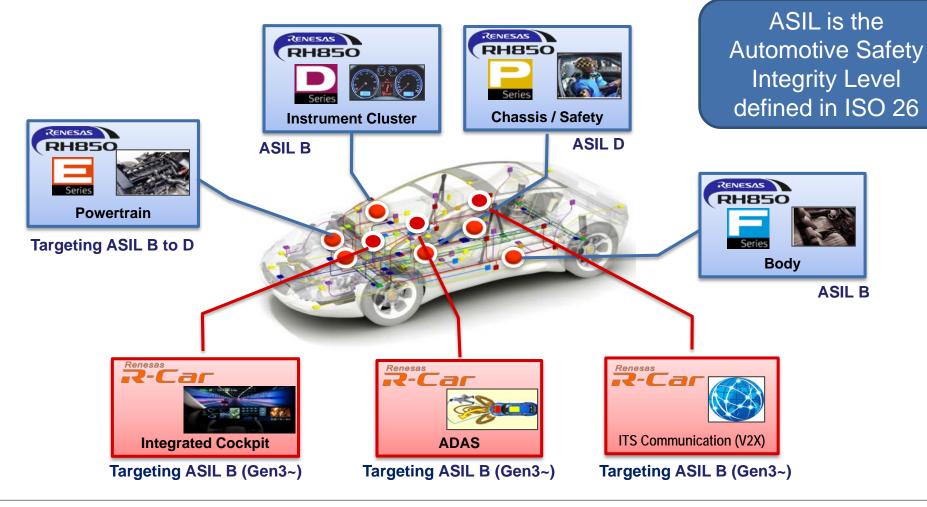
RENESAS ELECTRONICS CORPORATION

BIG IDEAS



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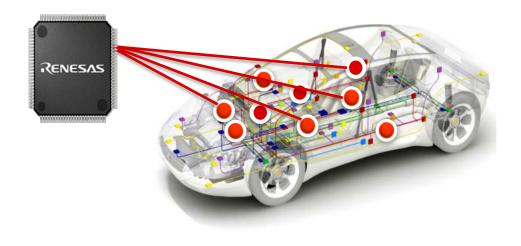
SAFETY IS A MANDATORY REQUEST FOR SEMICONDUCTORS





CHALLENGES IN APPLYING SEMICONDUCTOR TO SYSTEM

 In order to adapt a semiconductor to the customer's system, there are challenges during development. Below are some examples of challenges to realize development that is in compliance with ISO 26262.



*SEooC: Safety Element Out-of-context

Most products are developed as SEooC*, so the safety concept must be modified from assumptions to customer's "real" system.

Circuits are becoming more complex & larger. Calculating the metrics values for all elements is very laborious work.

As users make modifications during revisions of their safety analysis and architecture, a record of changes is required. Managing the revision history is very difficult.

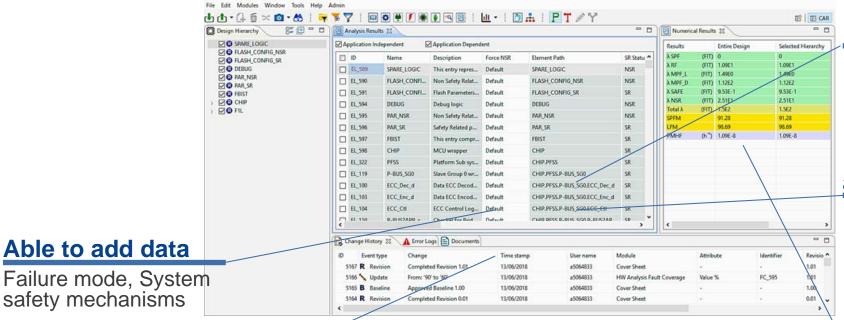


RENESAS IN-HOUSE FMEDA (CAR) TOOL CUSTOMIZABLE ANALYSIS REPORT

Automatic calculation saves time

Able to select/add Safety mechanisms depending on customer's system

Automatically record a modification history



Easy to control by GUI

Notifies input error/explanation

Able to add data

safety mechanisms

Reliable data base for Safety mechanisms

Applicable Safety mechanisms, **Diagnosis** coverage

Flexible parameter changes are possible

Failure rate, Failure type, Failure rate distributions, FTTI, etc.

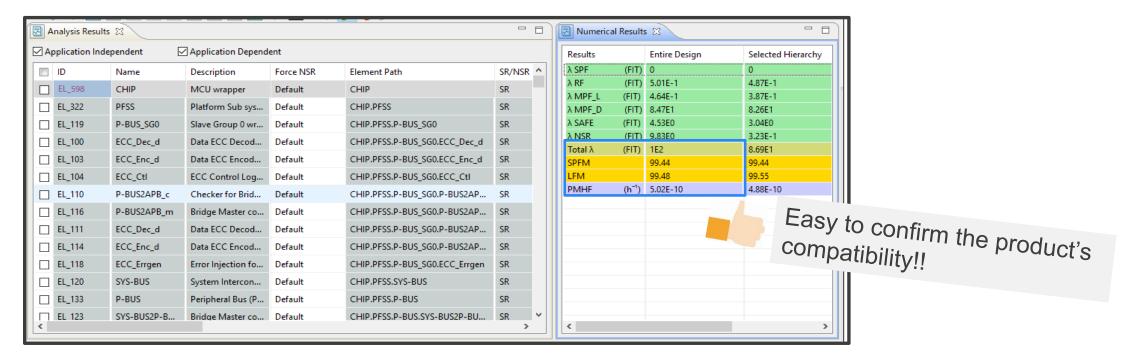
Parameters can be Automatically calculated

H/W Architectural metrics, Safety goal violation rate



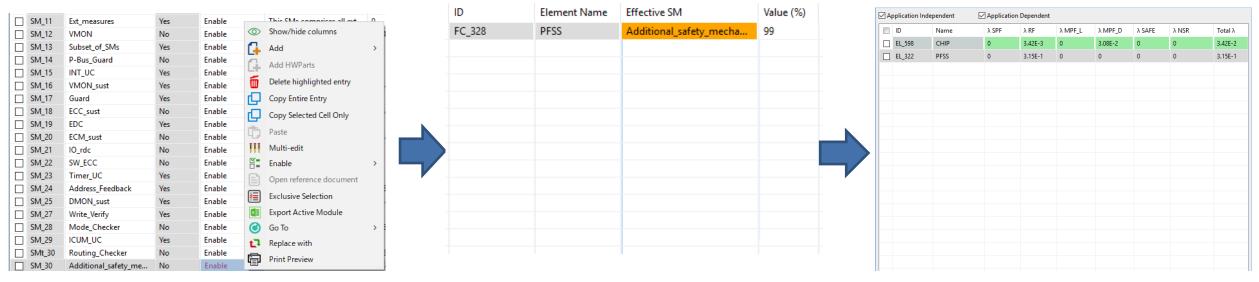
AUTOMATIC CALCULATION SAVES TIME

 GUI CAR tool automatically re-calculates the metric values (SPFM, LFM e.g.) upon user input data modifications (such as diagnostic coverage, Safety-relevance, etc.); the user can easily confirm achievement of their implementation!



ABLE TO SELECT/ADD SAFETY MECHANISMS DEPENDING ON CUSTOMER'S SYSTEM

Very easy to add/modify parameters, and metric values are automatically re-calculated.



Add a safety mechanism

Assign a safety mechanism and DC value to target element

Confirmation of re-calculated metric value

Only 3 steps to modify the safety mechanism.



AUTOMATICALLY RECORD A MODIFICATION HISTORY

 GUI CAR Tool automates revision control and change history generation, so users can easily manage and track what has been changed.

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CAR TOOL IS NOT JUST A CALCULATION TOOL

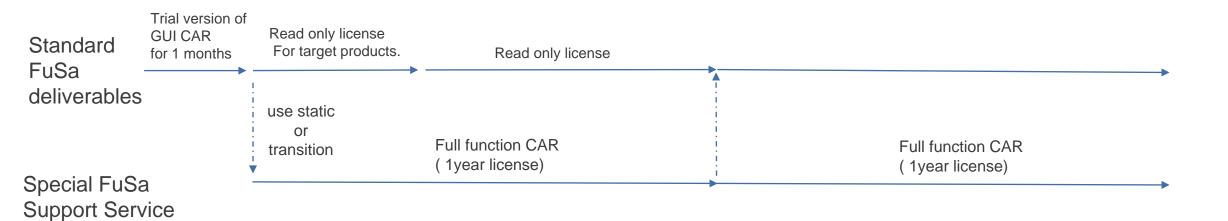
 Reference documents (e.g. functional safety work products) can be embedded in the GUI CAR tool and they can be accessed during safety analysis.

PARE_LOGIC	ID	Name	Element Path		ription	Size	Size Unit	Nature	Application In		a ABC-AB-17-0564_RH850F1KM_SAN_rev.1.0_sample.pdf — 🗆 🗙				
LASH_CONFIG_SR	EL_589	SPARE_LOGIC FLASH CONFIG NSR	SPARE_LOGIC FLASH CONFIG NSR		entry represents Safety Related po	4.95E-3	um2 um2	Die Die	Yes Yes	test2 test2	^				
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BIST	EL_595	PAR_NSR	PAR_NSR		Safety Related po	8.67E-2	um2	Die	Yes	test2					
CHIP	EL_596	PAR_SR	PAR_SR	Safet	ty Related portion	2.15E-2	um2	Die	Yes	test2	RH850/F1KM Group SAN				
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[🥵 Change H	listory 🛕 Error Logs	📄 Documents 🛛	3								This application note explains the recommended usage of safety mechanisms for the RH850/F1KM group (hereafter referred to as "RH850/F1KM").				
D ID	File Name		File version	Release	Used		Referen	ced in	ty Label		This application note is made based on the RH850/F1KH, RH850/F1KM hardware user's manual. Please refer to the latest version user's manual (R[1]) when using it.				
	ADC AD 17 0562 DI	-AB-17-0562_RH850_F1KM_SRS_rev.		12/06/2010	2018 No					-	This application note provides support for fulfilling the SEooC assumptions in the preparation of the required work products at the system level. Renesas Electronics does not take any resonability that the required ASIL level will be				
	_			13/06/2018			-				reached on system level. This is strictly dependent on the system configuration. Aim of this document is to provide				
2	ABC-AB-17-0563_RH	1850_F1KM_HSSR	1.0	13/06/2018	No		-				supplemental information for the assumed SW and system solutions to assist the compliance of ISO26262 (R[8]) in system integration.				
3	ABC-AB-17-0564_RH	1850F1KM_SAN_r	1.0	13/06/2018	No		-								
											Each section describes a safety mechanism and contains the following sub-sections:				
									_		Recommended Usage Any possible recommendations to bear in mind during the usage of the MCU to prevent possible				
											misbehaviors; it also gives suggestions to independent modules used in redundant configuration				
											• Faihre Control				
											o Definition of the assumed failure reaction and contra Easy 10 according				
		File Name	File version	Release	Used	Reference	d in				Software Test Description				
		ABC-AB-17-0562_RH850_F1 ABC-AB-17-0563_RH850_F1		13/06/2018 13/06/2018	No No	-					 Explanation of the software test description including procedures. 				
		ABC-AB-17-0565_RH850_F1K	-	13/06/2018	No	-					 Nechninalised Usage Any possible recommendations to bear in mind during the usage of the MCU to prevent possible misbehaviors; if also gives suggestions to independent modules used in redundat configuration to minimize interference when not all module functions Failure Control Definition of the assumed failure reaction and contr. Software Test Description Explanation of the software test description including provide the procedures. In relation to the proposed SW Safety Mechanisms, note that a proper test required full detection time (application dependent). With a lower test for accounted full detection time (application dependent). With a lower test for accounted for the increase in the Dagagostic Coverage as methodored in ISC. In this document, Renesas Electronics provide only a judgement on suitad on and/or run-time test, but does not provide any suggestion in regards to 				
				15, 55, 2010							required fault detection time (application dependent). With a lower test for accounted for the increase in the Diagnostic Coverage as mentioned in ISC				
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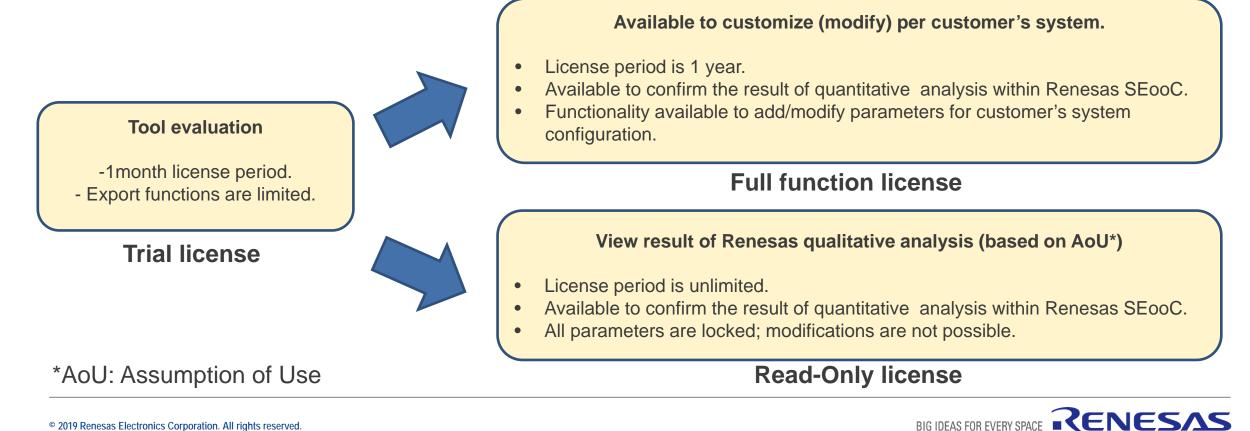
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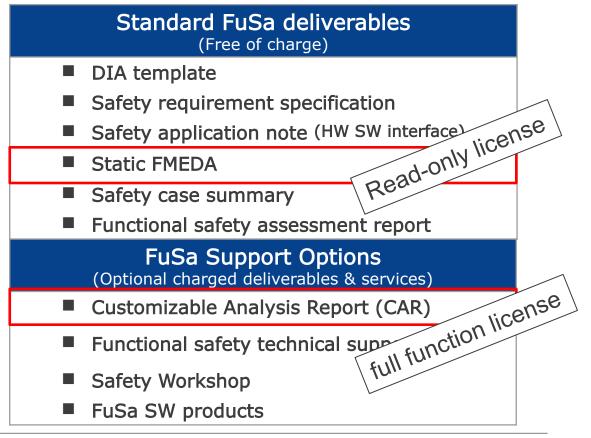
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HOW TO GET GUI CAR TOOL?

CAR tool is one of the work products in our safety support program.
 For details, please contact the local sales team.



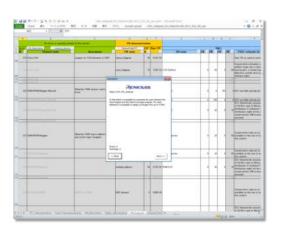


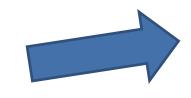
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TRANSITION PLAN FROM EXCEL BASE TO GUI BASE

 Renesas will provide GUI base CAR tool from next generation of MCU (RH850) and 3rd generation of SoC (R-Car). Gen1.0 & 1.5 MCU products are basically supported by Excel based CAR tool.
 For long term, we'll convert these data to GUI base CAR tool.





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GUI base CAR tool 2nd generation of MCU(x2x series) 3rd generation of SoC (x3x series) (TBD)

Excel base CAR tool Gen 1& Gen 1.5 products of MCU (x1x series)



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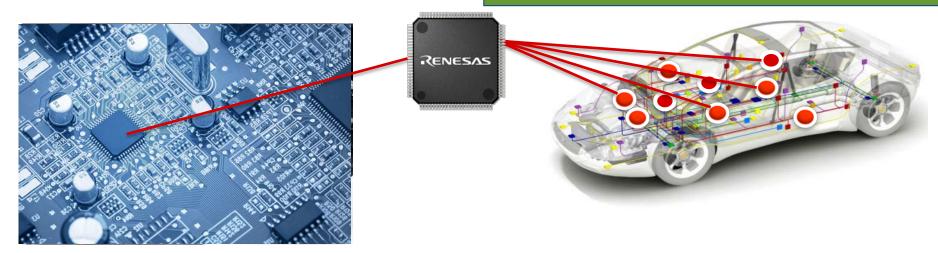
SEOOC*: CUSTOMIZATION CHALLENGES

In-Context:

- Intended for use in a specific item
- Safety goals are fixed
- Safety requirements are clearly defined
- Safety HW is customized for use case
- "Top-down" approach is mainly used

Out-of-context

- Intended for use in multiple and different items.
- Safety goal information only considered
- Safety requirements are assumed
- Safety HW is implemented based on assumed use
- Combination of "top-down" plus "bottom-up" approaches is used



*For this and all other slides, SEooC (Safety Element Out-of-Context) refers to a component.